4-Bit Bidirectional Voltage-Level Translator with Automatic Direction Sensing

1 FEATURES

- **No Direction-Control**
- **Data Rates**
  100Mbps
- **1.2V to 3.6V on A ports and 1.65V to 5.5V on B Ports ($V_{CCA} \leq V_{CCB}$)**
- **V_{CC} Isolation Feature: If Either V_{CC} Input is at GND, Both Ports are in the High-Impedance State**
- **Output Enable (OE) Input Circuit Referenced to V_{CCA}**
- **Low Power Consumption, 10μA Maximum I_{CC}**
- **No Power-Supply Sequencing Required: Either V_{CCA} or V_{CCB} can be Ramped First**
- **I_{OFF}: Supports Partial-Power-Down Mode Operation**
- **Extended Temperature: -40°C to 125°C**

2 APPLICATIONS

- **Handset**
- **Smartphone**
- **Tablet**
- **Desktop PC**

3 DESCRIPTIONS

This 4-bit non-inverting translator is a bidirectional voltage-level translator and can be used to establish digital switching compatibility between mixed-voltage systems. It uses two separate configurable power-supply rails, with the A ports supporting operating voltages from 1.2V to 3.6V while it tracks the V_{CCA} supply, and the B ports supporting operating voltages from 1.65V to 5.5V while it tracks the V_{CCB} supply. This allows the support of both lower and higher logic signal levels while providing bidirectional translation capabilities between any of the 1.2V, 1.5V, 1.8V, 2.5V, 3.3V and 5V voltage nodes.
V_{CCA} must not exceed V_{CCB}.

When the output-enable (OE) input is low, all outputs are placed in the high-impedance state, which significantly reduces the power-supply quiescent current consumption. OE has an internal pull-down current source, as long as V_{CCA} is powered.

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pull-down resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The RS0204A is available in Green UQFN1.7X2-12 and TSSOP14 packages. It operates over an ambient temperature range of -40°C to 125°C.

Device Information (1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
RS0204A	TSSOP14	5.00mm×4.40mm
	UQFN1.7X2-12	2.00mm×1.70mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

4 FUNCTIONAL BLOCK DIAGRAM

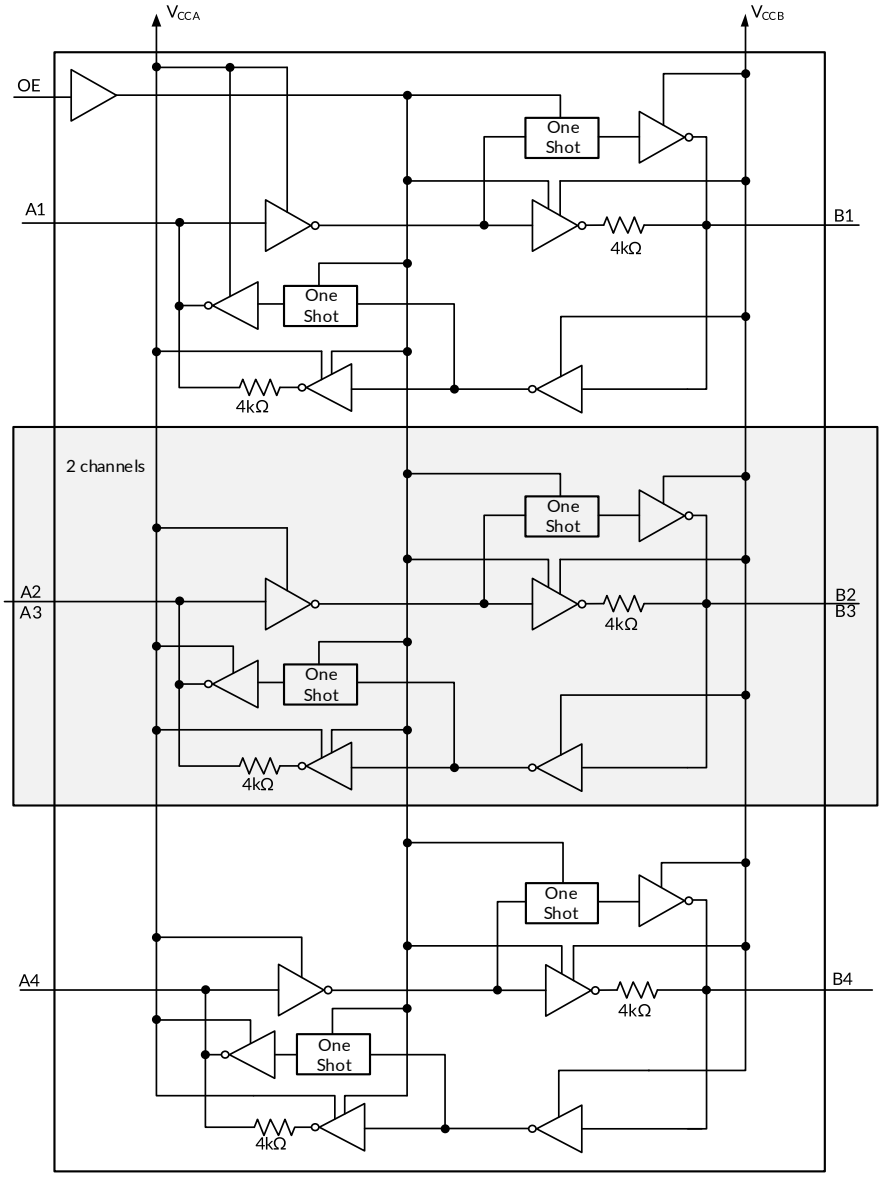


Table of Contents

5 REVISION HISTORY

Note: Page numbers for previous revisions may different from page numbers in the current version.

VERSION	Change Date	Change Item
A.1	2025/08/20	Initial version completed

6 PACKAGE/ORDERING INFORMATION (1)

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING (2)	MSL(3)	PACKAGE OPTION
RS0204A	RS0204AXQ	-40°C ~125°C	TSSOP14	RS0204A	MSL3	Tape and Reel, 4000
	RS0204AXUTQH12	-40°C ~125°C	UQFN1.7X2-12	0204A	MSL3	Tape and Reel, 4000

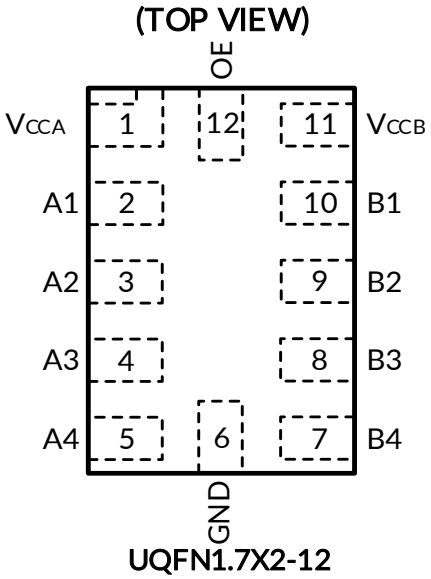
NOTE:

(1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.

(2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.

(3) RUNIC classify the MSL level with using the common preconditioning setting in our assembly factory conforming to the JEDEC industrial standard J-STD-20F, Please align with RUNIC if your end application is quite critical to the preconditioning setting or if you have special requirement.

7 PIN CONFIGURATIONS



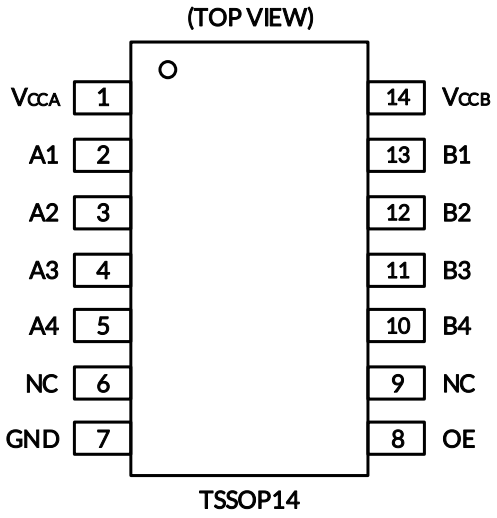
UQFN1.7X2-12

PIN DESCRIPTION

PIN	NAME	TYPE (1)	FUNCTION
UQFN1.7X2-12			
1	V_{CCA}	P	A Port Supply Voltage. 1.2V ≤ V_{CCA} ≤3.6V and V_{CCA} ≤ V_{CCB}.
2	A1	I/O	Input/output A1. Reference to V_{CCA}.
3	A2	I/O	Input/output A2. Reference to V_{CCA}.
4	A3	I/O	Input/output A3. Reference to V_{CCA}.
5	A4	I/O	Input/output A4. Reference to V_{CCA}.
6	GND	–	Ground.
7	B4	I/O	Input/output B4. Reference to V_{CCB}.
8	B3	I/O	Input/output B3. Reference to V_{CCB}.
9	B2	I/O	Input/output B2. Reference to V_{CCB}.
10	B1	I/O	Input/output B1. Reference to V_{CCB}.
11	V_{CCB}	P	B Ports Supply Voltage. 1.65V ≤ V_{CCB} ≤ 5.5V.
12	OE	I	Output Enable (Active High). Pull OE low to place all outputs in 3-state mode. Referenced to V_{CCA}.

(1) I=input, O=output, I/O=input and output, P=power.

PIN CONFIGURATIONS



PIN DESCRIPTION

PIN	NAME	TYPE (1)	FUNCTION
TSSOP14			
1	V_{CCA}	P	A Port Supply Voltage.1.2V ≤ V_{CCA} ≤ 3.6V and V_{CCA} ≤ V_{CCB}
2	A1	I/O	Input/output A1. Reference to V_{CCA}.
3	A2	I/O	Input/output A2. Reference to V_{CCA}.
4	A3	I/O	Input/output A3. Reference to V_{CCA}.
5	A4	I/O	Input/output A4. Reference to V_{CCA}.
6	NC	-	No internal connection.
7	GND	–	Ground.
8	OE	I	Output Enable (Active High). Pull OE low to place all outputs in 3-state mode. Referenced to V_{CCA}.
9	NC	-	No internal connection.
10	B4	I/O	Input/output B4. Reference to V_{CCB}.
11	B3	I/O	Input/output B3. Reference to V_{CCB}.
12	B2	I/O	Input/output B2. Reference to V_{CCB}.
13	B1	I/O	Input/output B1. Reference to V_{CCB}.
14	V_{CCB}	P	B Ports Supply Voltage.1.65V ≤ V_{CCB} ≤ 5.5V.

(1) I=input, O=output, I/O=input and output, P=power.

8 SPECIFICATIONS

8.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) (1)

SYMBOL	PARAMETER		MIN	MAX	UNIT
V_{CCA}	Supply Voltage Range		-0.3	4.6	V
V_{CCB}	Supply Voltage Range		-0.3	6.5	V
V_I (2)	Input Voltage Range	A port	-0.3	4.6	
		B port	-0.3	6.5	V
		OE	-0.3	4.6	
V_O (2)	Voltage range applied to any output in the high-impedance or power-off state	A port	-0.3	4.6	V
		B port	-0.3	6.5	
V_O (2)(3)	Voltage range applied to any output in the high or low state	A port	-0.3	V_{CCA}+0.3	V
		B port	-0.3	V_{CCB}+0.3	
I_{IK}	Input clamp current	V_I<0		-50	mA
I_{OK}	Output clamp current	Vo<0		-50	mA
I_O	Continuous output current			±50	mA
	Continuous current through V_{CCA}, V_{CCB} or GND			±100	mA
θ_{JA}	Package thermal impedance (4)	TSSOP14		121	°C/W
		UQFN1.7X2-12		120	
T_J	Junction Temperature (5)		-40	150	°C
T_{stg}	Storage temperature		-65	150	

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
(3) The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.
(4) The package thermal impedance is calculated in accordance with JESD-51.
(5) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

8.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

		VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge	Human-Body Model (HBM)	±2000	V
	Charged-Device Model (CDM)	±1000	
	Machine Model (MM)	±200	

ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

8.3 Recommended Operating Conditions

V_{CCI} is the supply voltage associated with the input port. V_{CCO} is the supply voltage associated with the output port. (1)(2)

PARAMETER	CONDITIONS			MIN	TYP	MAX	UNIT
Supply voltage	V_{CCA}			1.2		3.6	V
	V_{CCB}			1.65		5.5	
High-level input voltage (V_{IH})	A-port inputs	V_{CCA} = 1.2 V to 3.6 V V_{CCB} = 1.65 V to 5.5 V		V_{CCI} x 0.7 (3)		V_{CCI}	V
	B-port inputs	V_{CCA} = 1.2 V to 3.6 V V_{CCB} = 1.65 V to 5.5 V		V_{CCI} x 0.7		V_{CCI}	
	OE input	V_{CCA} = 1.2 V to 3.6 V V_{CCB} = 1.65 V to 5.5 V		V_{CCA} x 0.7		5.5	
Low-level input voltage (V_{IL})	A-port inputs	V_{CCA} = 1.2 V to 3.6 V V_{CCB} = 1.65 V to 5.5 V		0		V_{CCI} x 0.35 (3)	V
	B-port inputs	V_{CCA} = 1.2 V to 3.6 V V_{CCB} = 1.65 V to 5.5 V		0		V_{CCI} x 0.35	
	OE input	V_{CCA} = 1.2 V to 3.6 V V_{CCB} = 1.65 V to 5.5 V		0		V_{CCA} x 0.35	
Voltage applied to any output in the high-impedance or power-off state (Vo)	A-port	V_{CCA} = 1.2 V to 3.6 V V_{CCB} = 1.65 V to 5.5 V		0		3.6	V
	B-port	V_{CCA} = 1.2 V to 3.6 V V_{CCB} = 1.65 V to 5.5 V		0		5.5	
Input transition rise or fall rate (Δt/Δv)	A-port inputs	V_{CCA} = 1.2 V to 3.6 V V_{CCB} = 1.65 V to 5.5 V				40	ns/V
	B-port inputs	V_{CCA} = 1.2 V to 3.6 V	V_{CCB} = 1.65 V to 3.6 V			40	
			V_{CCB} = 4.5 V to 5.5 V			30	
T_A Operating free-air temperature				-40		125	°C

(1) The A and B sides of an unused data I/O pair must be held in the same state, that is, both at V_{CCI} or both at GND.
(2) V_{CCA} must be less than or equal to V_{CCB} and must not exceed 3.6 V.
(3) V_{CCI} is the supply voltage associated with the input port.

8.4 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (1) (2) (3)

PARAMETER		CONDITIONS	V_{CCA}	V_{CCB}	TEMP	MIN(4)	TYP(5)	MAX(4)	UNIT
V_{OHA}	Port A output high voltage	I_{OH} = −20 μA	1.2V		+25°C		1.1		V
			1.4V to 3.6V		Full	V_{CCA}-0.4			
V_{OLA}	Port A output low voltage	I_{OL} = 20 μA	1.2V		+25°C		0.3		
			1.4V to 3.6V		Full			0.4	
V_{OHB}	Port B output high voltage	I_{OH} = −20 μA		1.65V to 5.5V	Full	V_{CCB} - 0.4			
V_{OLB}	Port B output low voltage	I_{OL} = 20 μA		1.65V to 5.5V	Full			0.4	
I_I	Input leakage current	OE V_I=V_{CCI} or GND	1.2V to 3.6V	1.65V to 5.5V	+25°C			±1	μA
					Full			±2	
I_{off}	Partial power down current	A Ports V_I or Vo=0 to 3.6V	0V	0V to 5.5V	+25°C			±1	μA
					Full			±2	
		B Ports V_I or Vo=0 to 5.5V	0V to 3.6V	0V	+25°C			±1	μA
					Full			±2	
I_{OZ} (6)	High-impedance State output current	A or B port OE=GND	1.2V to 3.6V	1.65V to 5.5V	+25°C			±1	μA
					Full			±2	
I_{CCA}	V_{CCA} supply current	V_I=V_{CCI} or GND I_O = 0	1.2V	1.65V to 5.5V	+25°C		0.06		μA
			1.4V to 3.6V	1.65V to 5.5V	Full			5	
			3.6V	0V	Full			2	
			0V	5.5V	Full			-2	
I_{CCB}	V_{CCB} supply current	V_I=V_{CCI} or GND I_O = 0	1.2V	1.65V to 5.5V	+25°C		3.4		μA
			1.4V to 3.6V	1.65V to 5.5V	Full			5	
			3.6V	0V	Full			-2	
			0V	5.5V	Full			2	
I_{CCA} + I_{CCB}	Combined supply current	V_I = V_{CCI} or GND I_O = 0	1.2V	1.65V to 5.5V	+25°C		3.5		μA
			1.4V to 3.6V	1.65V to 5.5V	Full			10	
I_{CCZA}	V_{CCA} supply current	V_I = V_{CCI} or GND I_O = 0, OE=GND	1.2V	1.65V to 5.5V	+25°C		0.05		μA
			1.4V to 3.6V	1.65V to 5.5V	Full			5	
I_{CCZB}	V_{CCB} supply current	V_I = V_{CCI} or GND I_O = 0, OE=GND	1.2V	1.65V to 5.5V	+25°C		3.3		μA
			1.4V to 3.6V	1.65V to 5.5V	Full			5	
C_i	Input capacitance	OE	1.2V to 3.6V	1.65V to 5.5V	+25°C		4		pF
C_{io}	Input-to-output internal capacitance	A port	1.2V to 3.6V	1.65V to 5.5V	+25°C		5		pF
		B port	1.2V to 3.6V	1.65V to 5.5V	+25°C		9		

(1) V_{CCI} is the V_{CC} associated with the input port.
(2) V_{CCO} is the V_{CC} associated with the output port
(3) V_{CCA} must be less than or equal to V_{CCB}.
(4) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.
(5) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.
(6) For I/O ports, the parameter I_{OZ} includes the input leakage current.

8.5 Timing Requirements:

8.5.1 V_{CCA}=1.2V

T_A=25°C, V_{CCA}=1.2V

		V_{CCB}=1.8V	V_{CCB}=2.5V	V_{CCB}=3.3V	V_{CCB}=5V	UNIT
		TYP	TYP	TYP	TYP	
Data rate		20	20	20	20	Mbps
Pulse duration(t_w)	data inputs	50	50	50	50	ns

8.5.2 V_{CCA}=1.5V±0.1 V

T_A=25°C, V_{CCA}=1.5V±0.1V (unless otherwise noted)

		V_{CCB}=1.8V ±0.15V	V_{CCB}=2.5V ±0.2V	V_{CCB}=3.3V ±0.3V	V_{CCB}=5V ±0.5V	UNIT
		TYP	TYP	TYP	TYP	
Data rate		40	40	40	40	Mbps
Pulse duration(t_w)	data inputs	25	25	25	25	ns

8.5.3 V_{CCA}=1.8V±0.15 V

T_A=25°C, V_{CCA}=1.8V±0.15V (unless otherwise noted)

		V_{CCB}=1.8V ±0.15V	V_{CCB}=2.5V ±0.2V	V_{CCB}=3.3V ±0.3V	V_{CCB}=5V ±0.5V	UNIT
		TYP	TYP	TYP	TYP	
Data rate		50	50	50	50	Mbps
Pulse duration(t_w)	data inputs	25	25	25	25	ns

8.5.4 V_{CCA}=2.5V±0.2 V

T_A=25°C, V_{CCA}=2.5V±0.2V (unless otherwise noted)

		V_{CCB}=2.5V ±0.2V	V_{CCB}=3.3V ±0.3V	V_{CCB}=5V ±0.5V	UNIT
		TYP	TYP	TYP	
Data rate		70	80	80	Mbps
Pulse duration(t_w)	data inputs	14	12	12	ns

8.5.5 V_{CCA}=3.3V±0.3 V

T_A=25°C, V_{CCA}=3.3V±0.3V (unless otherwise noted)

		V_{CCB}=3.3V ±0.3V	V_{CCB}=5V ±0.5V	UNIT
		TYP	TYP	
Data rate		80	100	Mbps
Pulse duration(t_w)	data inputs	12	10	ns

8.6 Switching Characteristics: V_{CCA}=1.2V

T_A=25°C, V_{CCA}=1.2V

PARAMETER		CONDITIONS	V_{CCB}=1.8V			V_{CCB}=2.5V			V_{CCB}=3.3V			V_{CCB}=5V			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
t_{PHL}	Propagation delay time high-to-low output	A-to-B	7.2		27.1	4.8		18.0	4.3		16.2	4.3		16.0	ns
t_{PLH}	Propagation delay time low-to-high output	A-to-B	7.9		29.5	5.7		21.5	5.0		18.8	4.7		17.5	ns
t_{PHL}	Propagation delay time high-to-low output	B-to-A	8.6		32.3	6.1		22.8	5.2		19.6	4.6		17.3	ns
t_{PLH}	Propagation delay time low-to-high output	B-to-A	6.9		25.7	5.0		18.8	4.4		16.7	4.0		15.0	ns
t_{en}	Enable time	OE-to-A or B	150		589	125		500	116		465	115		460	ns
t_{dis}	Disable time	OE-to-A or B	290		1150	275		1100	265		1050	230		925	ns
t_{rA}, t_{fA}	Input rise time	A port rise and fall time	4		14.4	3		12.3	3		12.0	3		11.5	ns
t_{rB}, t_{fB}	Input rise time	B port rise and fall time	2		9.6	1		5.4	1		4.5	1		3.5	ns
Maximum data rate				20			20			20			20		Mbps

8.7 Switching Characteristics: V_{CCA}=1.5V ± 0.1V

over recommended operating free-air temperature range, V_{CCA}=1.5V±0.1V (unless otherwise noted)

PARAMETER		CONDITIONS	V_{CCB}=1.8V ±0.15V			V_{CCB}=2.5V ±0.2V			V_{CCB}=3.3V ±0.3V			V_{CCB}=5V±0.5V			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
t_{PHL}	Propagation delay time high-to-low output	A-to-B	5.9		21.9	3.4		12.7	2.7		10.2	2.5		9.4	ns
t_{PLH}	Propagation delay time low-to-high output	A-to-B	5.8		21.6	3.8		14.2	3.0		11.4	2.7		10.2	ns
t_{PHL}	Propagation delay time high-to-low output	B-to-A	6.6		24.9	4.5		17.0	4.0		14.9	3.5		13.0	ns
t_{PLH}	Propagation delay time low-to-high output	B-to-A	5.5		20.5	3.8		14.2	3.2		12.0	2.8		10.6	ns
t_{en}	Enable time	OE-to-A or B	130		520	125		500	110		455	100		430	ns
t_{dis}	Disable time	OE-to-A or B	275		1100	270		1090	260		1040	230		915	ns
t_{rA}, t_{fA}	Input rise time	A port rise and fall time	4		14.1	3		11.8	3		10.9	2		9.9	ns
t_{rB}, t_{fB}	Input rise time	B port rise and fall time	2		9.0	1		5.8	1		4.2	1		3.8	ns
Maximum data rate				40			40			40			40		Mbps

8.8 Switching Characteristics: V_{CCA}=1.8V ± 0.15V

over recommended operating free-air temperature range, V_{CCA}=1.8V±0.15V (unless otherwise noted)

PARAMETER		CONDITIONS	V_{CCB}=1.8V ±0.15V			V_{CCB}=2.5V ±0.2V			V_{CCB}=3.3V ±0.3V			V_{CCB}=5V±0.5V			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
t_{PHL}	Propagation delay time high-to-low output	A-to-B	5		20.5	3		11.1	2		8.9	2		7.6	ns
t_{PLH}	Propagation delay time low-to-high output	A-to-B	5		19.1	3		11.4	2		8.7	2		7.6	ns
t_{PHL}	Propagation delay time high-to-low output	B-to-A	5		20.5	3		13.0	3		11.4	3		10.2	ns
t_{PLH}	Propagation delay time low-to-high output	B-to-A	5		18.0	3		11.7	3		9.6	2		7.6	ns
t_{en}	Enable time	OE-to-A or B	125		500	120		490	110		445	100		420	ns
t_{dis}	Disable time	OE-to-A or B	265		1060	260		1040	255		1030	210		860	ns
t_{rA}, t_{fA}	Input rise time	A port rise and fall time	2.4		9.8	2.4		9.6	2.3		9.3	2.2		9.0	ns
t_{rB}, t_{fB}	Input rise time	B port rise and fall time	2.5		9.9	1.4		5.4	1.1		4.5	1.0		3.8	ns
Maximum data rate				50			50			50			50		Mbps

8.9 Switching Characteristics: V_{CCA}=2.5V ± 0.2V

over recommended operating free-air temperature range, V_{CCA}=2.5V±0.2V (unless otherwise noted)

PARAMETER		CONDITIONS	V_{CCB}=2.5V ±0.2V			V_{CCB}=3.3V ±0.3V			V_{CCB}=5V±0.5V			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
t_{PHL}	Propagation delay time high-to-low output	A-to-B	2.6		9.7	1.9		7.1	1.5		5.8	ns
t_{PLH}	Propagation delay time low-to-high output	A-to-B	2.6		9.7	1.9		7.1	1.5		5.8	ns
t_{PHL}	Propagation delay time high-to-low output	B-to-A	2.5		9.2	2.0		7.4	1.8		6.6	ns
t_{PLH}	Propagation delay time low-to-high output	B-to-A	2.5		9.4	1.9		7.3	1.5		5.8	ns
t_{en}	Enable time	OE-to-A or B	115		460	100		410	100		390	ns
t_{dis}	Disable time	OE-to-A or B	255		1020	250		1000	210		850	ns
t_{rA}, t_{fA}	Input rise time	A port rise and fall time	1		5.6	1		5.8	1		5.6	ns
t_{rB}, t_{fB}	Input rise time	B port rise and fall time	1		5.4	1		4.3	1		3.5	ns
Maximum data rate				70			80			80		Mbps

8.10 Switching Characteristics: V_{CCA}=3.3V ± 0.3V

over recommended operating free-air temperature range, V_{CCA}=3.3V±0.3V (unless otherwise noted)

PARAMETER		CONDITIONS	V_{CCB}=3.3V ±0.3V			V_{CCB}=5V ±0.5V			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
t_{PHL}	Propagation delay time high-to-low output	A-to-B	1.8		6.9	1.5		5.6	ns
t_{PLH}	Propagation delay time low-to-high output	A-to-B	1.8		6.8	1.5		5.4	ns
t_{PHL}	Propagation delay time high-to-low output	B-to-A	1.7		6.3	1.5		5.4	ns
t_{PLH}	Propagation delay time low-to-high output	B-to-A	1.8		6.9	1.3		5.0	ns
t_{en}	Enable time	OE-to-A or B	100		400	90		370	ns
t_{dis}	Disable time	OE-to-A or B	250		980	200		800	ns
t_{rA}	Input rise time	A port rise time	1.0		4.2	0.9		3.5	ns
t_{rB}	Input rise time	B port rise time	0.9		3.7	0.9		3.5	ns
t_{fA}	Input fall time	A port fall time	0.5		1.9	0.4		1.8	ns
t_{fB}	Input fall time	B port fall time	0.5		1.9	0.4		1.6	ns
Maximum data rate				80			100		Mbps

9 OPERATING CHARACTERISTICS

T_A=25°C

PARAMETER		CONDITIONS		V_{CCA}							UNIT
				1.2V	1.2V	1.5V	1.8V	2.5V	2.5V	3.3V	
				V_{CCB}							
				5V	1.8V	1.8V	1.8V	2.5V	5V	3.3V to 5V	
				TYP	TYP	TYP	TYP	TYP	TYP	TYP	
C_{pdA}	Power dissipation capacitance	C_L=0 f=10MHz t_r=t_f=1ns OE=V_{CCA} (outputs enabled)	A-port input B-port output	6	5	4	5	8	4	8	pF
			B-port input A-port output	12	11	12	12	12	12	12	
C_{pdB}	Power dissipation capacitance		A-port input B-port output	22	19	19	19	20	21	22	
			B-port input A-port output	27	22	17	17	16	19	19	
C_{pdA}	Power dissipation capacitance	C_L=0 f=10MHz t_r=t_f=1ns OE=GND (outputs enabled)	A-port input B-port output	0.01	0.01	0.01	0.01	0.01	0.01	0.01	pF
			B-port input A-port output	0.01	0.01	0.01	0.01	0.01	0.01	0.01	
C_{pdB}	Power dissipation capacitance		A-port input B-port output	0.01	0.01	0.01	0.01	0.01	0.01	0.01	
			B-port input A-port output	0.01	0.01	0.01	0.01	0.01	0.01	0.01	

10 PARAMETER MEASUREMENT INFORMATION

Unless otherwise noted, all input pulses are supplied by generators having the following characteristics:

- PRR 10 MHz
- Z_O = 50 Ω
- dv/dt ≥ 1 V/ns

Note: All input pulses are measured one at a time, with one transition per measurement.

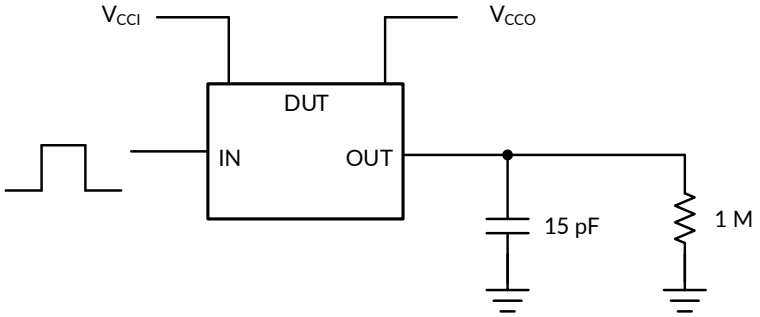


Figure 1. Data Rate, Pulse Duration, Propagation Delay, Output Rise And Fall Time Measurement Using A Push-Pull Driver

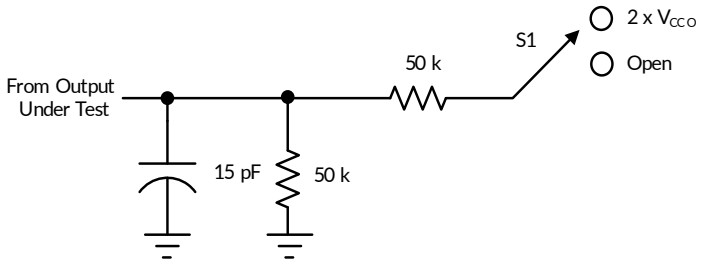
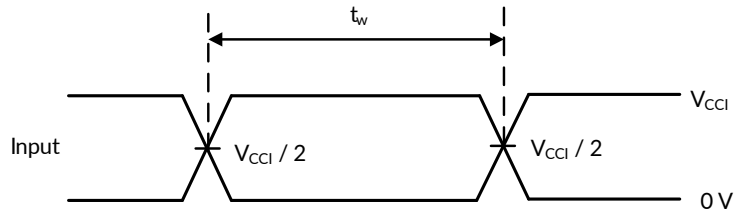


Figure 2. Load Circuit for Enable/Disable Time Measurement

Table 1. Switch Configuration for Enable/Disable Timing

TEST	S1
t_{PZL}(1), t_{PLZ}(2)	2 × V_{CCO}
t_{PHZ}(1), t_{PZH}(2)	Open

(1) t_{PZL} and t_{PZH} are the same as t_{en}.
(2) t_{PLZ} and t_{PHZ} are the same as t_{dis}.



(1) All input pulses are measured one at a time, with one transition per measurement.

Figure 3. Voltage Waveforms Pulse Duration

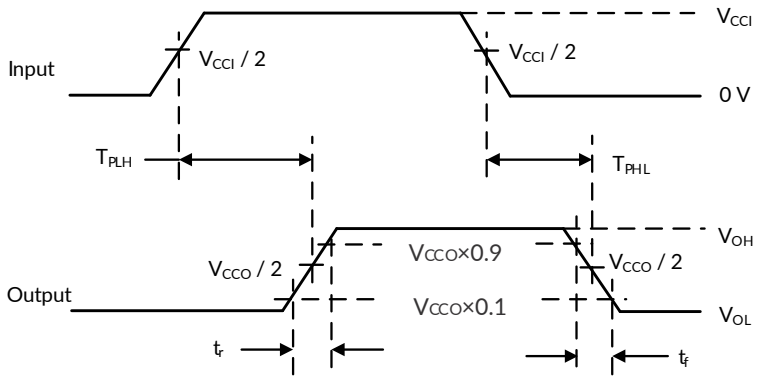
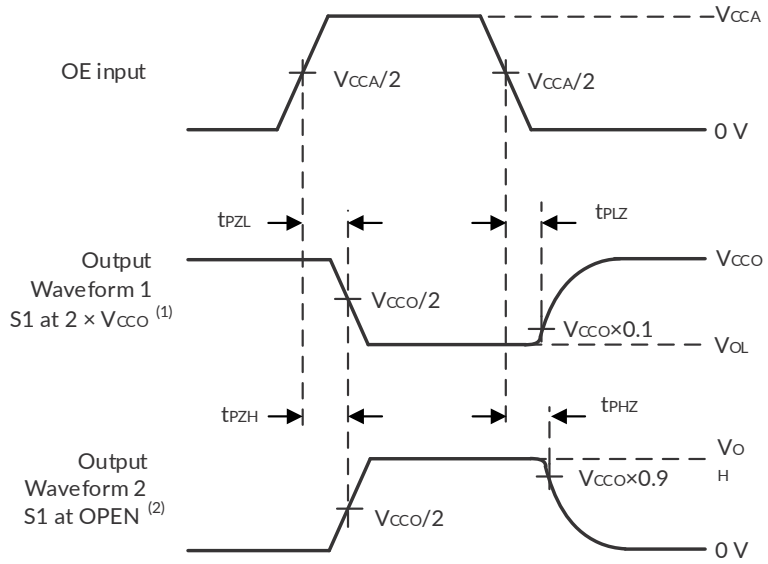


Figure 4. Voltage Waveforms Propagation Delay Times



A. Waveform 1 is for an output with internal such that the output is high, except when OE is high.
B. Waveform 2 is for an output with conditions such that the output is low, except when OE is high.

Figure 5. Voltage Waveforms Enable and Disable

11 DETAILED DESCRIPTION

11.1 Overview

The RS0204A device is a 4-bit, directionless voltage-level translator specifically designed for translating logic voltage levels. The A port is able to accept I/O voltages ranging from 1.2 V to 3.6 V, while the B port can accept I/O voltages from 1.65 V to 5.5 V. The device is a buffered architecture with edge-rate accelerators (one-shots) to improve the overall data rate. This device can only translate push-pull CMOS logic outputs. If for open-drain signal translation, please refer to RS010X products.

11.2 Architecture

The RS0204A device architecture (see Figure 6) does not require a direction-control signal to control the direction of data flow from A to B or from B to A. In a DC state, the output drivers of the device maintain a high or low, but are designed to be weak, so the output drivers can be overdriven by an external driver when data on the bus flows the opposite direction.

The output one-shots detect rising or falling edges on the A or B ports. During a rising edge, the one-shot turns on the PMOS transistors (T1, T3) for a short duration, which speeds up the low-to-high transition. Similarly, during a falling edge, the one-shot turns on the NMOS transistors (T2, T4) for a short duration, which speeds up the high-to-low transition. The typical output impedance during output transition is 70 Ω at V_{CCO} = 1.2 V to 1.8 V, 50 Ω at V_{CCO} = 1.8 V to 3.3 V, and 40Ω at V_{CCO} = 3.3 V to 5 V.

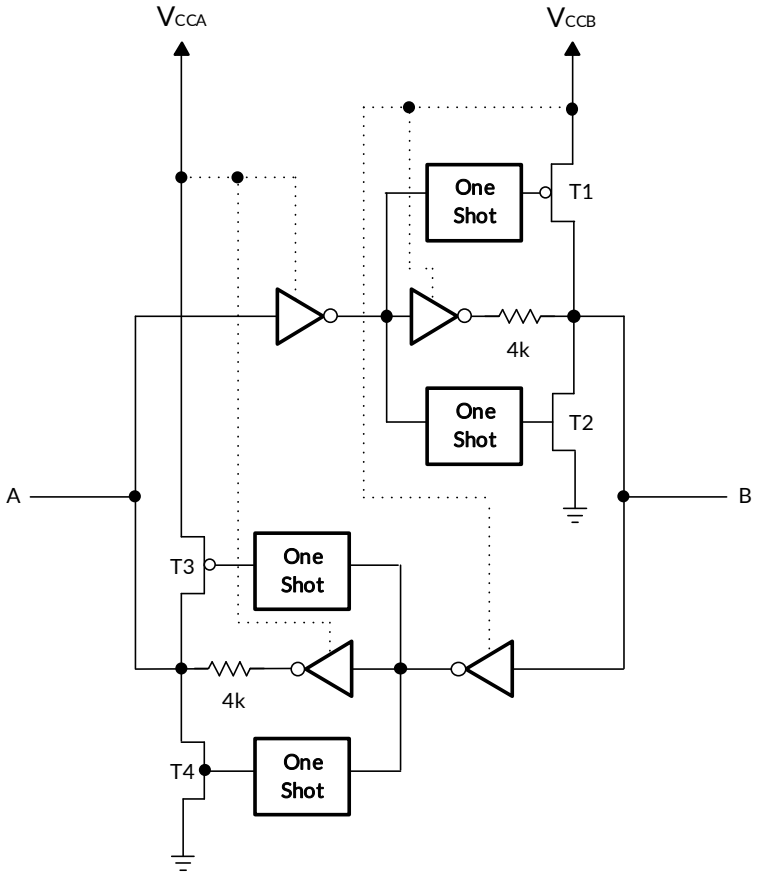
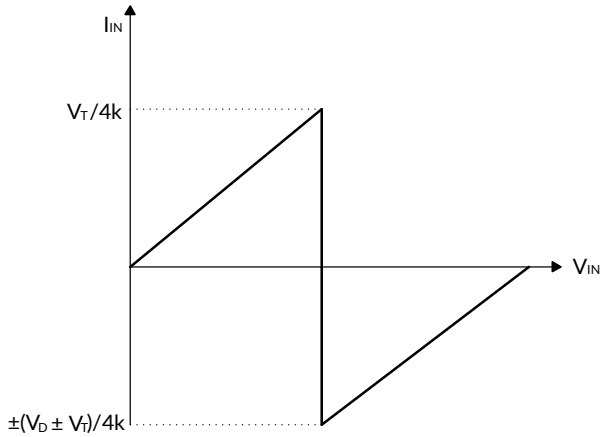


Figure 6. Architecture of RS0204A Device I/O Cell

11.3 Input Driver Requirements

Typical I_{IN} vs V_{IN} characteristics of the device are shown in Figure 7. For proper operation, the device driving the data I/Os of the RS0204A device must have driven strength of at least ±2 mA.



(1) V_T is the input threshold of the RS0204A device, (typically V_{CC} / 2).
(2) V_D is the supply voltage of the external driver.

Figure 7. Typical I_{IN} vs V_{IN} Curve

11.4 Output Load Considerations

We recommend careful PCB layout practices with short PCB trace lengths to avoid excessive capacitive loading and to ensure that proper O.S. triggering takes place. PCB signal trace-lengths must be kept short enough such that the round-trip delay of any reflection is less than the one-shot duration. This improves signal integrity by ensuring that any reflection sees a low impedance at the driver. The O.S. circuits have been designed to stay on for approximately 10 ns. The maximum capacitance of the lumped load that can be driven also depends directly on the one-shot duration. With very heavy capacitive loads, the one-shot can time-out before the signal is driven fully to the positive rail. The O.S. duration has been set to best optimize trade-offs between dynamic I_{CC}, load driving capability, and maximum bit-rate considerations. Both PCB trace length and connectors add to the capacitance that the device output sees, so it is recommended that this lumped-load capacitance be considered to avoid O.S. retriggering, bus contention, output signal oscillations, or other adverse system-level affects.

11.5 Enable and Disable

The RS0204A device has an OE input that is used to disable the device by setting OE = low, which places all I/Os in the high-impedance (Hi-Z) state. The disable time (t_{dis}) indicates the delay between when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time (t_{en}) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

11.6 Pullup or Pulldown Resistors on I/O Lines

The device is designed to drive capacitive loads of up to 70 pF. The output drivers of the RS0204A device have low dc drive strength. If pullup or pulldown resistors are connected externally to the data I/Os, their values must be kept higher than 50 kΩ to ensure that they do not contend with the output drivers of the RS0204A device.

For the same reason, the RS0204A device must not be used in applications such as I^2C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O. For these applications, use a device from the RS010X series of level translators.

11.7 Device Functional Modes

The device has two functional modes, enabled and disabled. To disable the device, set the OE input to low, which places all I/Os in a high impedance state. Setting the OE input to high will enable the device.

12 APPLICATION AND IMPLEMENTATION

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

12.1 Application Information

The RS0204A device can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. It can only translate push-pull CMOS logic outputs. Any external pulldown or pullup resistors are recommended larger than 50 kΩ.

12.2 Typical Application

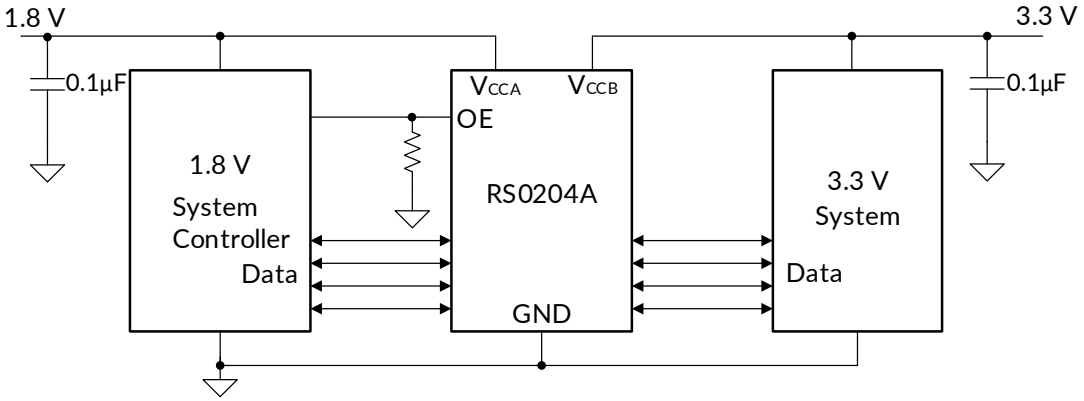
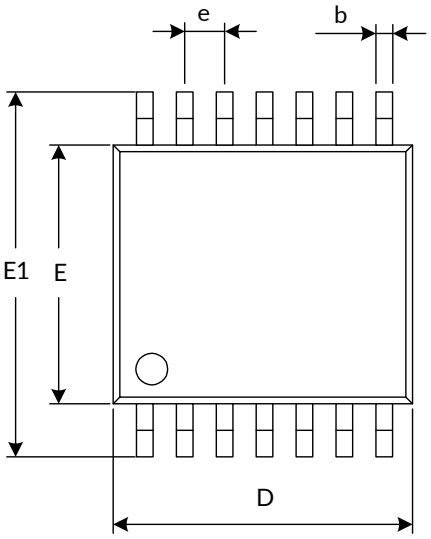
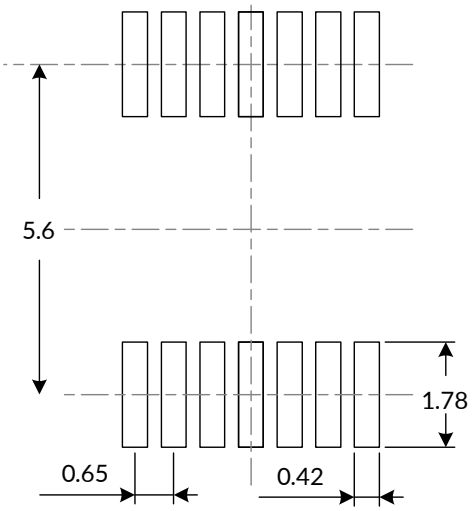


Figure 8. Typical Application Circuit

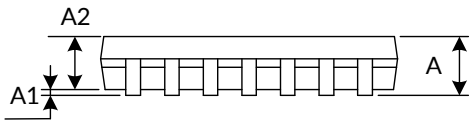
13 PACKAGE OUTLINE DIMENSIONS

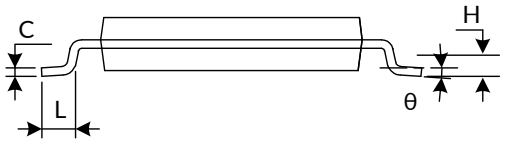
TSSOP14 (3)





RECOMMENDED LAND PATTERN (Unit: mm)



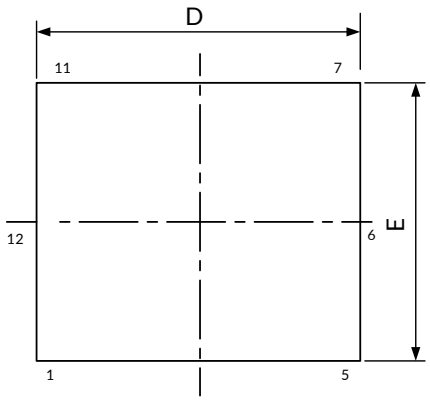


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A (1)		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D (1)	4.860	5.100	0.191	0.201
E (1)	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650(BSC) (2)		0.026(BSC) (2)	
L	0.500	0.700	0.020	0.028
H	0.250(TYP)		0.010(TYP)	
θ	1°	7°	1°	7°

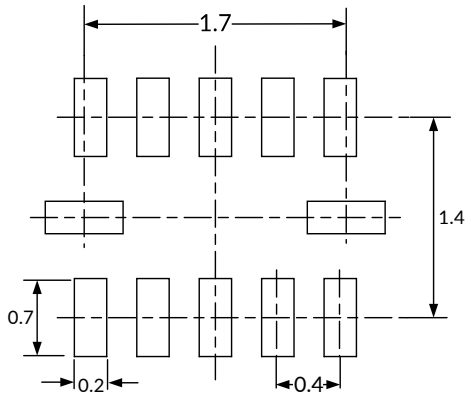
NOTE:

1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
3. This drawing is subject to change without notice.

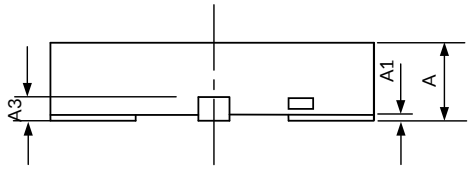
UQFN1.7X2-12 (4)



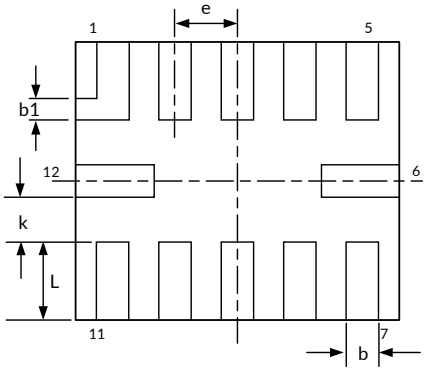
TOP VIEW



RECOMMENDED LAND PATTERN (Unit: mm)



SIDE VIEW



BOTTOM VIEW

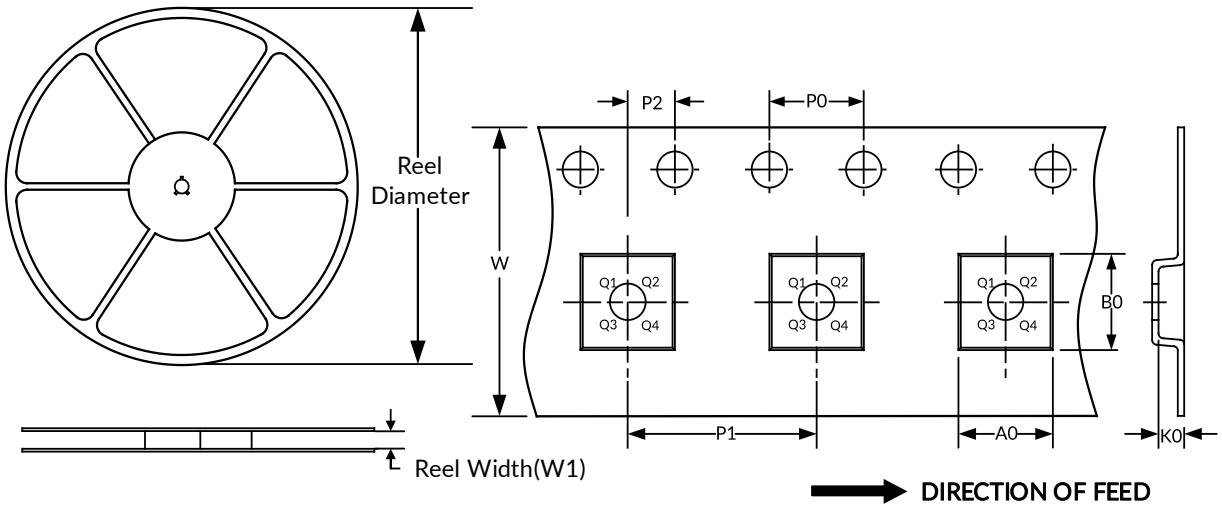
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A (1)	0.450	0.550	0.018	0.022
A1	0.000	0.050	0.000	0.002
A3	0.152 REF (2)		0.006 REF (2)	
D (1)	1.900	2.100	0.075	0.083
E (1)	1.600	1.800	0.063	0.071
b	0.150	0.250	0.006	0.010
b1	0.150 REF (2)		0.006 REF (2)	
k	0.250 REF (2)		0.010 REF (2)	
e	0.400 BSC (3)		0.016 BSC (3)	
L	0.400	0.600	0.016	0.024

NOTE:

1. Plastic or metal protrusions of 0.075mm maximum per side are not included.
2. REF is the abbreviation for Reference.
3. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
4. This drawing is subject to change without notice.

14 TAPE AND REEL INFORMATION

REEL DIMENSIONS TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TSSOP14	13”	12.4	6.95	5.60	1.20	4.0	8.0	2.0	12.0	Q1
UQFN1.7X2-12	7”	9.0	1.90	2.30	0.75	4.0	4.0	2.0	8.0	Q1

NOTE:
1. All dimensions are nominal.
2. Plastic or metal protrusions of 0.15mm maximum per side are not included.

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